APPLICAI	BLE STAN	DARD								
	Operating Temperature Range Voltage Current		-40 °C to 140 °C (1) To		Storage Temperat	ure Range		-10 °C to 60 °C (2) Relative humidity 60% max (Not dewed)		
Rating					Storage F	lumidity Range	(Not dewed)			
					Operating	perating Humidity Range Relative humidity 85 (Not dewed)		% max	(
			SPEC	IFICA	ΓIONS		·			
IT	EM		TEST METHOD			REQL	JIREMENTS	QT	Α	
CONSTRU		<u> </u>			I			1	1:-	
General Exar		Examine	d visually and with a measur	ring instrur	nent.			×	×	
Marking			d visually.		Accord	ding to the dra	wing.	×	×	
ELECTRIC	CAL CHAR	ACTERIS	STICS					1		
Contact Resistance		Measured at 100 mA MAX.(DC or 1000Hz)			65 m Ω	65mΩ MAX.			-	
Insulation Resistance		Measured at 250 V DC.				1000 MΩMIN.			-	
Voltage Proof		375 V AC applied for 1 min.			No flas	No flashover or breakdown.			_	
	CAL CHAR							×		
Mating and	****	Measured with an applicable connector.				Mating Force: 40 N MAX. Unmating Force: 4.4 N MIN.			-	
Unmating Forces Mechanical Operation		Mated and unmated 10 times.				①Contact Resistance : 75m Ω MAX.			+	
Modification Operation		ividica and unmated to times.			_	②No damage, cracks or looseness of parts.				
Vibration Shock		Frequency 50~100 → 100~150 → 150~300Hz				①No electrical discontinuity of more than 1 μs.			†-	
		Acceleration 98 \rightarrow 98~294 \rightarrow 294 m/s ²				②No damage, cracks or looseness of parts.				
		1 cycle 3 min								
		3 h for 3 axial directions (4) Acceleration 980 m/s ² , duration of pulse 6 ms						×	-	
		at 3 times for 3 axial directions.						^		
ENVIRON	MENTAL C		TERISTICS						1	
Damp Heat			at 60±2 °C, 90 ~ 95 %	, 1000 h	. (1)Con	tact Resistance	ce:75mΩ MAX.	×	1 -	
(Steady state))	'		,		②Insulation Resistance : 1000 MΩ MIN. /3				
Rapid Change of		Temperature -40 → +140 °C			3No (damage, crack	s or looseness of parts.	×	-	
Temperature		Time 30 → 30 min.								
		under 100		MINI)						
Cold		(Relocation time to chamber : within 2~3 MIN)				toot Dooistons	20 . 75 m O MAV	×	-	
Dry Heat			Exposed at -40°C, 1000 h Exposed at 140°C, 1000 h			①Contact Resistance : 75mΩ MAX. ②No damage, cracks or looseness of parts.			+=	
Sulfur Dioxide			at 40±2°C, 80±5%RH, 25:	+5ppm /	Λ Ω1	Contact Resistance : 75m Ω MAX.			+	
		for 96 h.				011100.01000		×		
Resistance to Soldering Heat		1)Reflow soldering : Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec				No deformation of case of excessive looseness of the terminal.			-	
Solderability		Soldered at solder temperature 240±3°C for immersion duration, 3 sec.				A new uniform coating of solder shall cover a minimum of 95 % of the surface being			-	
					immer	immersed.				
COUN	IT D	 ESCRIPTION	ON OF REVISIONS		DESIGNED		CHECKED	D/	ATE	
3 1		DIS-	F-00016361		TK. ABE		HH. SHINDO	2022	2121	
lotes (1)		rature rise caused by current-carrying. neans a long-term storage state for the unused produc				APPROVE		2019		
(2)					oroduct	CHECKED KN. SHIBUYA		2019		
(3)	before assem The creepage		distance conforms to IEC 60664-1.			DESIGNED	Titl. STITESTA	201909		
	Voltage effe	ctive value: 32V AC, Pollution Degree: 2				DD AMAL WAS ASSESSED.				
	<u> </u>		een connector mounting part and PCB is 0.05mm MA					2019		
Note QT:Q	ualification Te	st AT:Assurance Test X:Applicable Test				NG NO.		-376629-00-00		
HG GLOWION GLIEF				PART NO.		FX26-40P-1SV		ı		
	2-1 HIF	OSE EI	ECTRIC CO., LTD.		CODE NO.	CL05	576-1004-0-00	<u> </u>	1/	